Zener Diode

### DZ3S068D0L

## **Panasonic**

### DZ3S068D0L

### Silicon epitaxial planar type

For surge absorption circuit

#### ■ Features

- · Excellent rising characteristics of zener current Iz
- · Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

### ■ Marking Symbol:02

#### ■ Packaging

Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)

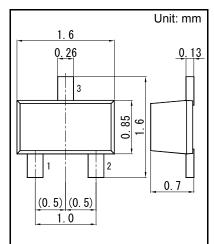
### ■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit	
Total power dissipation *1	PT	150	mW	
Electrostatic discharge *2	ESD	±10	kV	
Junction temperature	Tj	Tj 150		
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note) \*1: Mounted on glass epoxy print board. ( 45 mm x 45 mm x 1 mm) (2 Diode total)

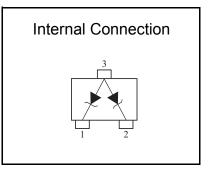
Solder in (0.6 mm x 0.6 mm)

\*2: Test method:IEC61000 4 2(C = 150 pF,R = 330  $\Omega$ , Contact discharge:10 times)



- 1. Cathode1
- 2. Cathode2
- 3. Anode1,2

1	
Panasonic	SSMini3-F3-B
JEITA	SC-89
Code	SOT-490



#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	6.46		7.14	V
Zener operating resistance	RZ	IZ = 5 mA			30	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			60	Ω
Reverse current	IR	VR = 4 V			0.1	μΑ
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		3.1		mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

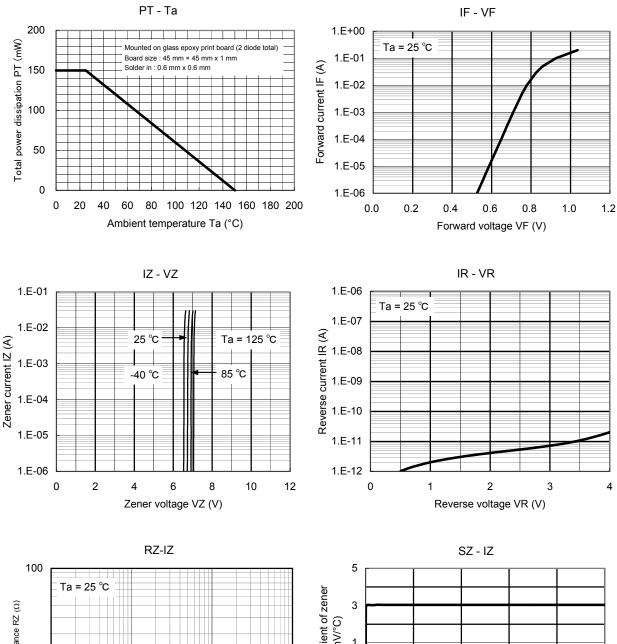
- \*1: The temperature must be controlled 25°C for VZ mesurement.
   VZ value measured at other temperature must be adjusted to VZ (25°C)
  - \*2: VZ guaranted 20 ms after current flow.
  - \*3: Tj = 25°C to 150°C

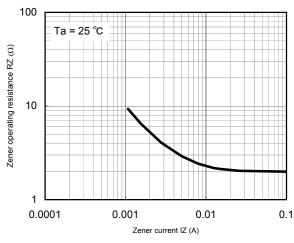
Zener Diode

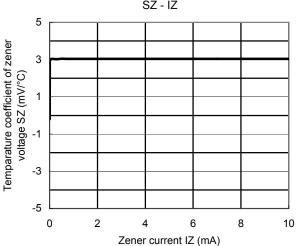
## DZ3S068D0L

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## Technical Data (reference)







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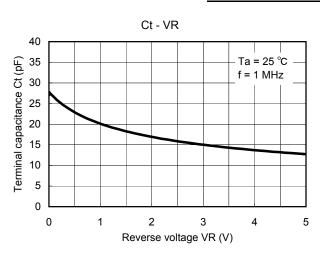
Revision. 3

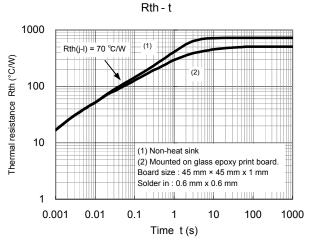
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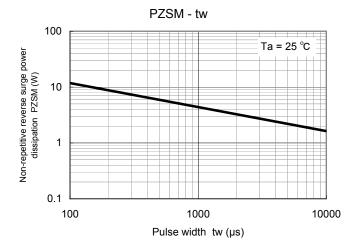
Zener Diode

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## Technical Data (reference)







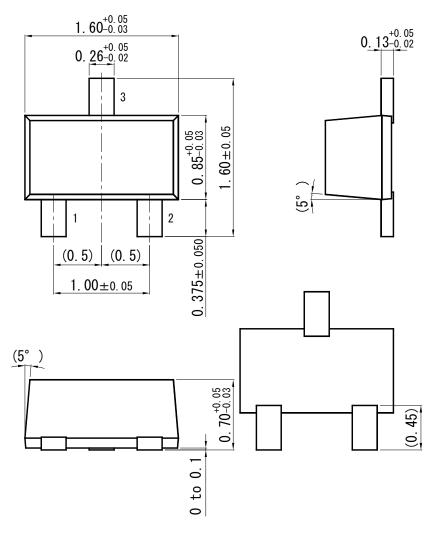
Zener Diode

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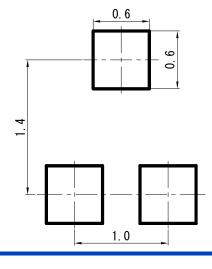
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SSMini3-F3-B

Unit: mm



### ■ Land Pattern (Reference) (Unit: mm)



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